### Technologies for Mass Producing IFE Targets and Determining Their Survival in an IFE Target Chamber



"The big lie in (laser–based) fusion is that we can make these target capsules for a nickel a piece"

> Professor Edward C. Morse, March 2010 issue of Scientific American (page 57)

We need to reduce the cost of the target by a factor of ~100,000

J. D. Zuegel D. R. Harding, <sup>1</sup> T. B. Jones,<sup>2</sup> R. Gram, M. Bobeica, <sup>1</sup> Z. Bei,<sup>3</sup> and W. Wang<sup>3</sup> University of Rochester Laboratory for Laser Energetics

#### Also

<sup>1</sup>Department of Chemical Engineering <sup>2</sup>Department of Electrical and Computer Engineering <sup>3</sup>Department of Materials Science NAS/NAE Committee on the Prospects for IFE Systems San Ramon, CA 29 January 2011



#### Summary

### Prospects for making IFE targets to the desired specifications (including cost) are promising



- The ICF program has developed techniques for making targets with the required specifications
  - the choice of techniques prioritized success and flexibility over cost
- Mass-producing a single type of target for less than \$0.50 each requires the production process to be more precise, repeatable, and reliable
- We are developing electric-field mediated microfluidic techniques for making direct-drive fusion energy targets
  - complete "cradle-to-grave" concept
  - completed studies confirm high through-put and high precision
  - considerable additional work is needed
  - key issues of precision, miniaturization, automation, target survival into the target chamber, and tritium considerations are addressed



#### **OMEGA-scale DT-wetted foam targets have demonstrated** acceptable capsule and ice specifications

UR



# The main issues with using the current foam-target fabrication process for IFE is the low yield (<10%) and high tritium inventory

(i) Microencapsulation: oil−water−oil double emulsion ✓ (ii) Wall-thickness control **?** 





- (iii) Solvent removal—CO<sub>2</sub> critical point drying ✓
- (iv) Overcoat—5- $\mu$ m CH permeation barrier (yield <10%), **?** 100-nm Au/Pd radiation barrier
- (v) DT permeation ICF target: requires 1000 atm DT and takes 3 days IFE target: requires 1100 atm DT and takes 7 days – 1 atm <sup>3</sup>He and 7 kg T<sub>2</sub>
- (vi) DT ice layer formation—14 hr to achieve full density and single crystal structure  $\underbrace{\mathsf{Liquid}}_{\mathsf{Liquid}} 26 \mathsf{K} \qquad \underbrace{\mathsf{Layered}}_{\mathsf{Layered}} \mathsf{Liquid}_{\mathsf{Liquid}} \mathsf{Liquid} \mathsf{Liquid} \mathsf{Liquid}_{\mathsf{Liquid}} \mathsf{Liquid}_{\mathsf{Liquid}} \mathsf{Liquid}_{\mathsf{Liquid}} \mathsf{Liquid} \mathsf{L$



#### Technologies based upon electric-field mediated microfluidics may offer an alternative way to mass produce targets that is more deterministic and better suited for automation





#### We have demonstrated the capabilities and limitations of this concept for producing capsules; the discrete steps need to be integrated

Water

reservoir

(i) Formed and moved droplets into an emulsion



Oil reservoir

(iii) Formed a photo-initiated polymer capsule





(ii) Centered the emulsion



 $\frac{\text{Oil/water/oil}}{E_0 = 6000 \text{ V/m}}$ f = 20 MHz Shell conductivity =  $2.4 \times 10^{-3} \text{ S/m}$ 

(iv) Developing a photo-initiated foam with the desired properties<sup>\*</sup>



\*R. R. Paguio *et al.*, presented at the 2010 MRS Fall Meeting, Boston, MA, 29 November–3 December 2010 (Paper BB12.5).

## The feasibility of extending the "lab-on-a-chip" concept to forming the DT-ice layer is being investigated

**1.** Form liquid DT into discrete droplets

2. Wick liquid into the foam shell



**3.** Condense Ne (Ar,Kr,Xe) as a barrier coating onto the foam



 Form ice layer – move through a thermal gradient (20 K → 19.5 K) at 0.001 K/5 min

LLE



5. Inject target – Ne overcoat ablated during transit

Tailor Ne thickness to insulate the target



An electro-mechanical microfluidic scheme is proposed for filling the target with DT.



## An E-field has been used to levitate a column of liquid $D_2$ and form a droplet of the desired volume (14 $\mu L)$



3. The D<sub>2</sub> droplets can be moved laterally



**Electrodes de-powered** 



1.8 KV on the rightmost electrode



UR 🔌

**Electrodes de-powered** 

This is a first demonstration of dielectrophoretic behavior in a cryogenic liquid.



### Liquid $D_2$ (14 ml) is rapidly absorbed (<10 s) into a foam shell at 25 K





(i) 3.2 mm dia; Liquid  $D_2$ 0.1 gm/cc R-F foam droplet shell (350  $\mu$ m wall)



(ii) Liquid moved to the electrode containing foam shell



(iii) Liquid encapsulating and infiltrating the foam shell



(iv) Encapsulation and infiltration continues...



(v) Liquid infiltrating the foam wall



(vi) Liquid fully absorbed in the foam wall, shell void is not filled



### Developing a viable condensed-gas seal coat is critical to simplifying the DT-filling and target injection operations

### Candidate materials and considerations

Advantages:	Gas	Properties
<ul> <li>Faster filling; reduces the amount of tritium</li> <li>Eliminates need for Pd radiation barrier <ul> <li>sublimation protects against heat load</li> <li>heat load: 0.2 to 10 W;</li> <li>(2 mJ needed to sublime a monolayer Ne ⇒ ~100-nm layer)</li> </ul> </li> </ul>	Ne	<ul> <li>High P<sub>vapor</sub> at 18 K</li> <li>Heat conducting gas for layering</li> <li>Low E<sub>sublimation</sub>, sublimes rapidly during target injection</li> </ul>
		• 100- $\mu$ m × 0.1- $\mu$ m grain size (FCC crystal)
<ul> <li>Issues to be addressed:</li> <li>Required thickness and composition of the overcoat</li> <li>Demonstrate uniform sublimation</li> </ul>	Xe	<ul> <li>Low P<sub>vapor</sub> (~10<sup>-13</sup> torr) readily condenses at 38 K</li> <li>High E<sub>sublimation</sub> → slow removal during</li> </ul>
during target injection		injection



### The heat load to the target and the effect on the ice during injection into the chamber were estimated using Monte Carlo and CFD models

Conditions: 4000 K gas temperature; 400 ms<sup>-1</sup> target velocity; 0.05-torr Xenon gas



# Comparatively high heat loads (1.4 W) have no effect on the inner ice surface because of the low thermal diffusivity and brief residence time in the chamber

- Model includes sublimation and melting
- Model assumes a radiation barrier and no outer sacrificial Xe overcoat

Melt fraction and temperature distribution of the ice after 0.05 s (anticipated time for target to traverse the chamber radius)



• Inner-ice-surface temperature preserved by the low thermal diffusivity and the high  $H_{\rm fusion}$  of DT

1.4 W for the 0.05-s estimated transit time to TCC melts the outer surface of the ice layer but leaves the inner surface unaffected – an outer Xe/Ne insulation layer on the target would provide further protection.



### The calculated effects of a high temperature gas on the ice layer can be tested in existing equipment

"Surrogate IFE chamber" – e-beam heated tungsten nozzle producing a supersonic beam of Xenon atoms "Surrogate target" – cylinder filled with D<sub>2</sub> and embedded with temperature sensors that also measure the rate the liquid/solid phase changes



- gas temperature > 2000°C
- heat flux 14 kW/m<sup>2</sup>
- atomic flux  $3\times 10^{22}$  atom/m^2
- gas pressure of 0.001 torr





E18783a

### Prospects for making IFE targets to the desired specifications (including cost) are promising

- The ICF program has developed techniques for making targets with the required specifications
  - the choice of techniques prioritized success and flexibility over cost
- Mass-producing a single type of target for less than \$0.50 each requires the production process to be more precise, repeatable, and reliable
- We are developing electric-field mediated microfluidic techniques for making direct-drive fusion energy targets
  - complete "cradle-to-grave" concept
  - completed studies confirm high through-put and high precision
  - considerable additional work is needed
  - key issues of precision, miniaturization, automation, target survival into the target chamber, and tritium considerations are addressed

